



TI DN 2510512 Rev A
May 2009

DLP® Pico DMD-B SCHMATIC

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Reference

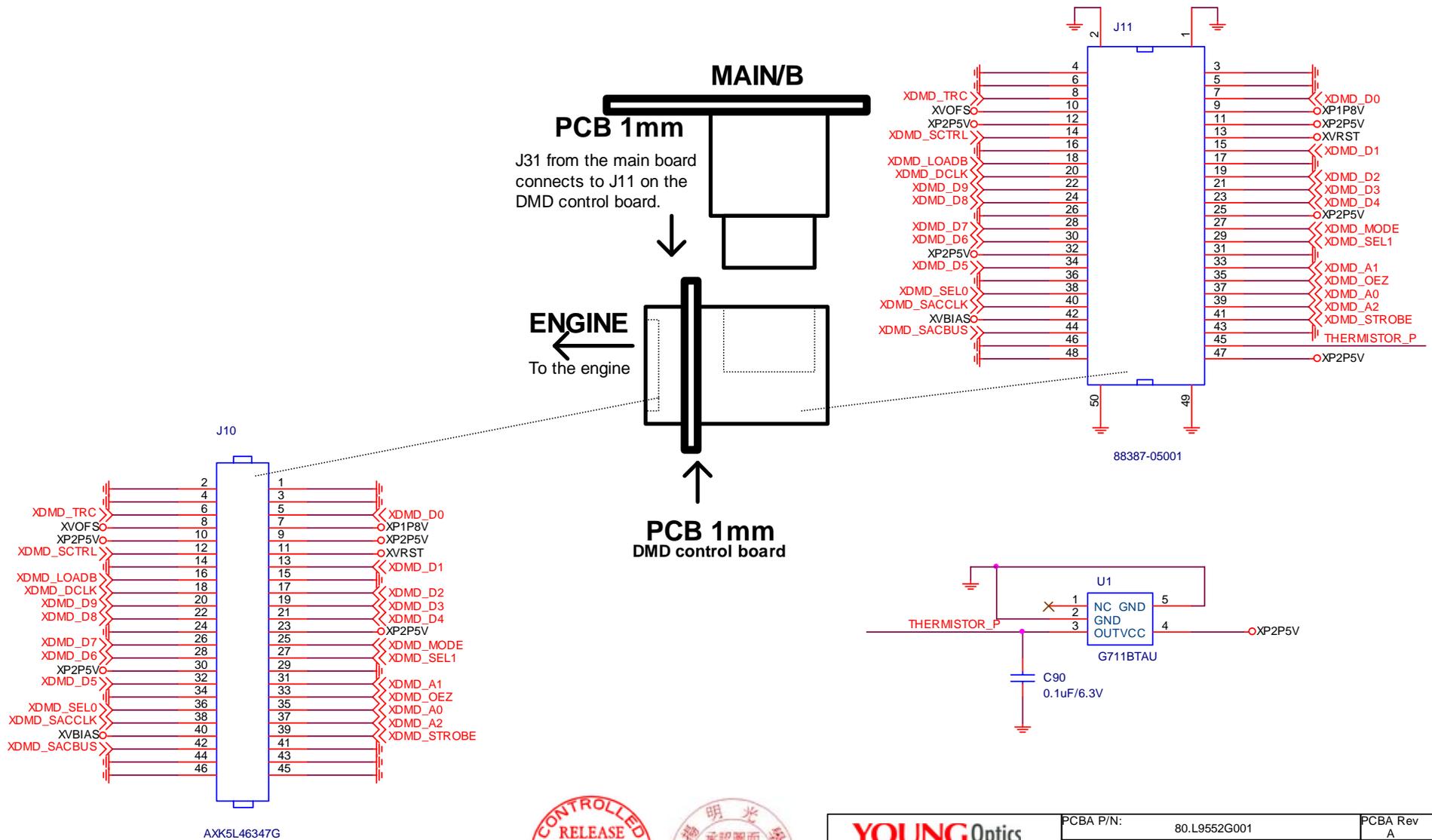
1. DLP® Pico Kit Functional Guide, TI drawing number 2510476
2. DLP® Pico Chipset Interface Manual, TI drawing number 2510477
3. DLP® Pico MAIN-B SCHEMATIC, TI drawing number 2510510
4. DLP® Pico DVI-B SCHEMATIC, TI drawing number 2510511
5. DLP® Pico Geber MAIN BOARD, TI drawing number 2510513
6. DLP® Pico Geber DVI BOARD, TI drawing number 2510514
7. DLP® Pico Geber DMD CONTROL BOARD, TI drawing number 2510515

DLP® Pico Kit DMD control board schematic

For a reference of the DLP® Pico Kit DMD control board schematic see the file, ***TI2510512_L9552G001_DMD-B-SCHMATIC_B01_03302009.DSN***. This file contains the schematic information for the Pico Kit DMD control board.

How do I get the design file?

The design file for the DLP® Pico Kit DMD control board schematic is available to you through an authorized DLP® Discovery™ value-added reseller (VAR). A list of the VARs can be found at: www.dlpdiscovery.com/var. Please reference the file name above when contacting a VAR.



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Daniel	Larry	Larry	DMD Transfer BD with Thermal sensor			
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